IPC ASSOCIATION C ELECTRONICS	© Copyright 2005. ]	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
upplier l	Information														
Company name*			Company ur	Company unique ID			Unique ID Authority				Respo	Response Date*			
onsemi											2025-0	2025-06-05			
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roduct-Er	nv-Stewards	Product Enviro Compliance			]	NA				Prod	Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr I		tem Number Mfr Item Name				Effective Date Version Manufacturing S		anufacturing Site	,	Weight*	UOM	Unit Type		
		1N4754A-T50A 39V 1W 5% ZEN		ER DO41		2025-06-05 CN2			324.186	mg	Each				
	turing Process Informa			A 11	(TT) 020 MG	T. D. C	D 1 D	D 1 T		N	1.7		CD G	1	
	8		Terminal Base Alloy J-STI CU Alloy NA		-STD-020 MS	L Rating	Peak Process Body Temperature Max Time  0 C 30			1.			cles		
	Matte Tin (Sn) - annealed		O Alloy	Γ	NA		U		IC	130	sec	onds 3			
omments															
	nformation regarding material	•,•	1 6 4												

RoHS Material Composition Declaration			Declaration 7	Гуре *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and cornect to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s	does not contain RoHS restricted substances	per the definition above except for sele	ted exemptions	Supplier Acceptance	* Accepted					
Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	E								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
CSS Wire	202.316	mg	Supplier	Sulfur (S)	7704-34-9		0.1012	mg
			Supplier	Carbon (C)	7440-44-0		1.0116	mg
			Supplier	Manganese (Mn)	7439-96-5		0.4046	mg
			Supplier	Iron (Fe)	7439-89-6		129.988	mg
			Supplier	Copper (Cu)	7440-50-8		70.7094	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1012	mg
Die	0.093	mg	Supplier	Silicon (Si)	7440-21-3		0.093	mg
Dumet Wire	57.927	mg	Supplier	Manganese (Mn)	7439-96-5		0.5213	mg
			Supplier	Silicon (Si)	7440-21-3		0.2317	mg
			В	Nickel (Ni)	7440-02-0		18.3339	mg
			Supplier	Iron (Fe)	7439-89-6		25.2851	mg
			Supplier	Copper (Cu)	7440-50-8		13.5549	mg
Glass Encapsulation	60.33	mg	Supplier	Boron Trioxide (B2O3)	1303-86-2		1.8099	mg
			A	Lead Oxide (PbO)	1317-36-8	7c	36.922	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.0302	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		2.2624	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		19.3056	mg
Plating	3.52	mg	Supplier	Tin (Sn)	7440-31-5		3.52	mg